

MOTOROLA SEMICONDUCTOR

TECHNICAL DATA

**MPS-U01
MPS-U01A**

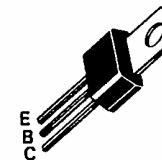
**NOT RECOMMENDED
FOR NEW DESIGNS**

SILICON ANNULAR TRANSISTORS

Designed for complementary symmetry audio circuits to 10
Watt output.

- Low Collector-Emitter Saturation Voltage —
 $V_{CE(sat)} = 0.5 \text{ Vdc (Max)} @ I_C = 1.0 \text{ Adc}$
- Complements to PNP MPS-U51 and MPS-U51A
- Uniwatt Package for Excellent Thermal Properties —
1.0 Watt @ $T_A = 25^\circ\text{C}$

NPN SILICON AUDIO TRANSISTORS



MAXIMUM RATINGS

Rating	Symbol	MPS-U01	MPS-U01A	Unit
Collector-Emitter Voltage	V_{CEO}	30	40	Vdc
Collector-Base Voltage	V_{CB}	40	50	Vdc
Emitter-Base Voltage	V_{EB}	5.0		Vdc
Collector Current — Continuous	I_C	2.0		Adc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	1.0	8.0	Watt mW/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	10	80	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150		$^\circ\text{C}$

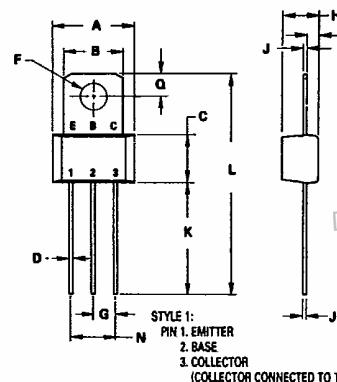
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	12.5	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA(1)}$	125	$^\circ\text{C/W}$

(1) $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

Uniwatt packages can be To-S lead formed by adding -6 to the device title and tab formed for flush mounting by adding -1 to the device title.

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NOTE:

1. LEADS WITHIN 0.15 mm (0.006) TOTAL OF TRUE POSITION AT CASE, AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.14	2.53	0.084	0.0375
B	2.60	2.74	0.102	0.0285
C	3.41	5.56	0.134	0.223
D	0.38	0.53	0.015	0.021
F	3.18	3.38	0.125	0.131
G	2.54 BSC		0.100 BSC	
H	3.94	4.19	0.155	0.165
J	0.36	0.41	0.014	0.016
K	11.63	17.20	0.455	0.672
L	24.58	25.53	0.968	1.005
M	5.08 BSC		0.200 BSC	
N	2.38	2.69	0.094	0.106
R	1.14	1.40	0.045	0.055

CASE 152-02

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (1) ($I_C = 10 \mu\text{Adc}, I_B = 0$)	$V_{(\text{BR})\text{CEO}}$ MPS-U01 MPS-U01A	30 40	— —	Vdc
Collector-Base Breakdown Voltage ($I_C = 100 \mu\text{Adc}, I_E = 0$)	$V_{(\text{BR})\text{CBO}}$ MPS-U01 MPS-U01A	40 50	— —	Vdc
Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{Adc}, I_C = 0$)	$V_{(\text{BR})\text{EBO}}$	5.0	—	Vdc
Collector Cutoff Current ($V_{CB} = 30 \text{ Vdc}, I_E = 0$) ($V_{CB} = 40 \text{ Vdc}, I_E = 0$)	I_{CBO} MPS-U01 MPS-U01A	— —	0.1 0.1	μAdc
Emitter Cutoff Current ($V_{BE} = 3.0 \text{ Vdc}, I_C = 0$)	I_{EBO}	—	0.1	μAdc
ON CHARACTERISTICS(1)				
DC Current Gain ($I_C = 10 \mu\text{Adc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 100 \mu\text{Adc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 1.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc}$)	h_{FE}	55 60 50	— — —	—
Collector-Emitter Saturation Voltage ($I_C = 1.0 \text{ Adc}, I_B = 0.1 \text{ Adc}$)	$V_{CE(\text{sat})}$	—	0.5	Vdc
Base-Emitter On Voltage ($I_C = 1.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc}$)	$V_{BE(\text{on})}$	—	1.2	Vdc
DYNAMIC CHARACTERISTICS				
Current-Gain-Bandwidth Product ($I_C = 50 \mu\text{Adc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz}$)	f_T	50	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$)	C_{ob}	—	20	pF

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

FIGURE 1 – DC CURRENT GAIN DataSheet4U.com

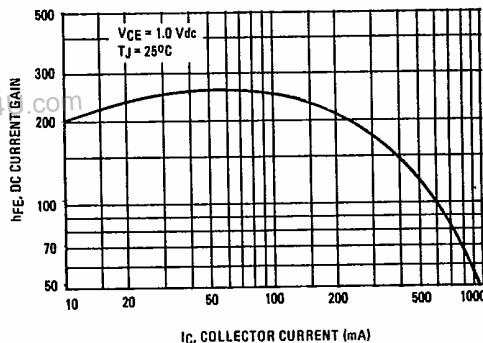


FIGURE 2 – “ON” VOLTAGES

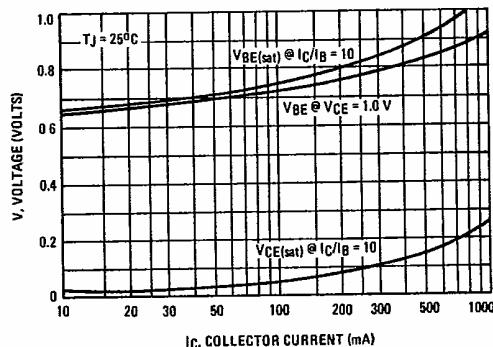
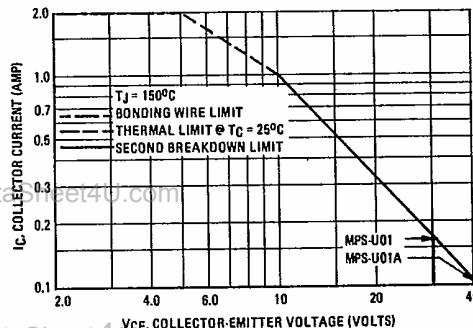


FIGURE 3 – DC SAFE OPERATING AREA



There are two limitations on the power handling ability of a transistor: junction temperature and secondary breakdown. Safe operating area curves indicate I_C - V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 3 is based on $T_J = 150^\circ\text{C}$ and $V_{BE} = 1.2 \text{ V}$ depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.